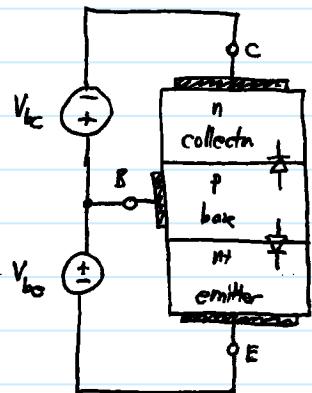
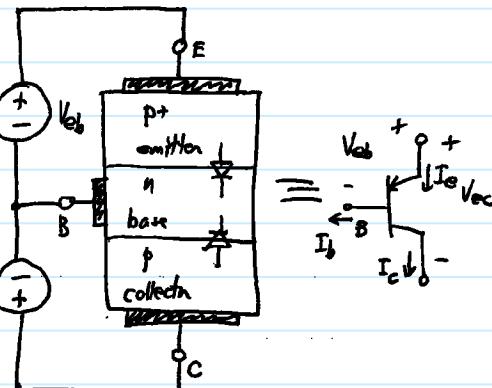


Modeling the Bipolar Junction Transistor (BJT)

⇒ physically, BJT's are just back-to-back pn junctions

npn bipolar Xistorpnp bipolar XistorRegions of Bipolar Xistor OperationERJCBJMode

Key: R = reverse-biased
F = forward-biased

R

R

Cut-off (both diodes off)

F

R

Forward Active (widely used in analog amplification etc.)

R

F

Reverse Active

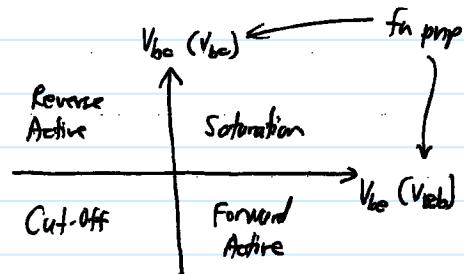
F

F

Saturation

⇒ can also think of this in a convenient graphical sense:

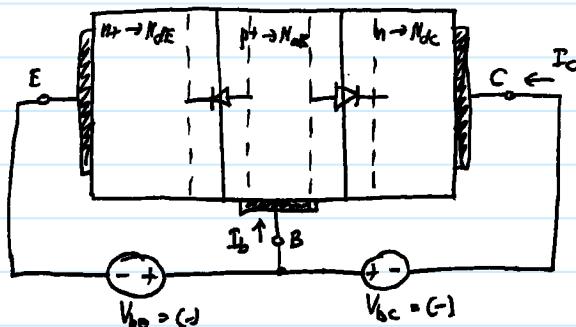
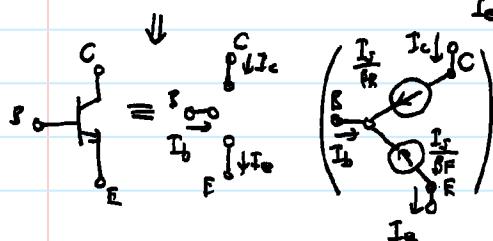
→ for npn (pnp):

① Cut-off Region - (npn transistor)

⇒ both diodes reverse-biased

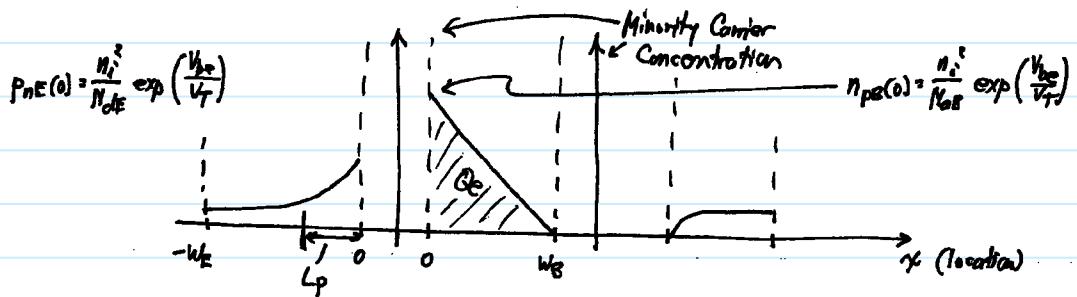
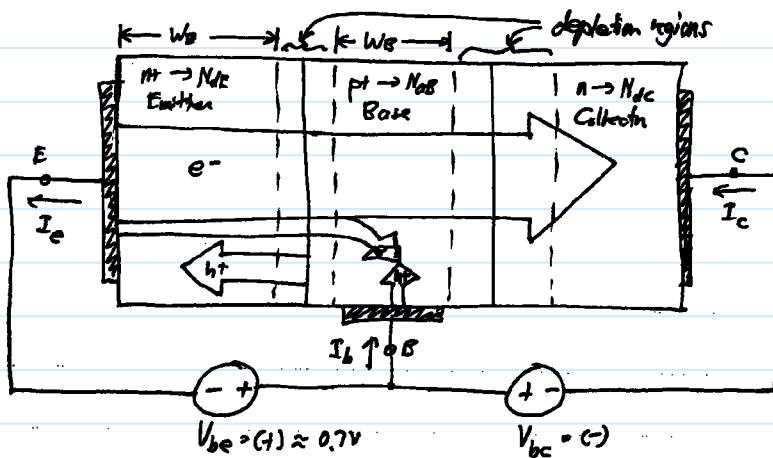
⇒ no current flows:

$$I_b = 0, I_c = 0, I_e = 0$$



② Forward-Active Region - (npn transistor)

⇒ BEJ Forward-Biased (i.e., diode on), BCJ Reverse-Biased (i.e., diode off)



Forward biasing of the BEJ generates three current components:

① e⁻'s injected from emitter to base: $I_{neB} = -A J_{neB}^{diff}$

② h⁺'s injected from base to emitter: $I_{phE} = A J_{phE}^{diff}$

③ recombination of e⁻'s & h⁺'s in base: I_{rB}

$$I_e = I_{neB} = ①$$

$$I_e = I_{neB} + I_{phE} + I_{rB} = ① + ② + ③$$

$$I_B = I_{phE} + I_{rB} = ② + ③$$

$$I_{neB} = -A J_{neB}^{diff} = -A q D_{neB} \frac{dn_{pe}(x)}{dx} = -q A D_{neB} \frac{[n_{pe}(w_B) - n_{pe}(0)]}{w_B} = q A D_{neB} \frac{n_i^2}{N_{DE} w_B} \exp\left(\frac{V_{be}}{V_T}\right) = ① *$$

diffusion constant
for e⁻'s in E

diffusion constant
for h⁺'s in E

$$\begin{cases} n_{pe}(w_B) = \frac{n_i^2}{N_{DE}} \exp\left(\frac{V_{be}}{V_T}\right) \approx 0 \\ n_{pe}(0) = \frac{n_i^2}{N_{DE}} \exp\left(\frac{V_{be}}{V_T}\right) \end{cases}$$

$$I_e = I_s \exp\left(\frac{V_{be}}{V_T}\right)$$

$$I_{phE} = A J_{phE}^{diff} = A q D_{phE} \frac{dn_{pe}(x)}{dx} = q A D_{phE} \frac{[n_{pe}(0) - n_{pe}(-w_B)]}{w_B} = q A D_{phE} \frac{n_i^2}{N_{DE} w_B} \exp\left(\frac{V_{be}}{V_T}\right) = ② *$$

slope

$$\begin{cases} n_{pe}(0) = \frac{n_i^2}{N_{DE}} \exp\left(\frac{V_{be}}{V_T}\right) \\ n_{pe}(-w_B) \approx 0 \end{cases}$$

could also replace
by diffusion length, L_p
(for h⁺ in npn
mode)

$$I_{IB} = \frac{Qe}{\tau_b} = \frac{1}{\tau_b} \left[\frac{1}{2} n_p \sigma(0) W_B q A \right] = \frac{1}{2} \frac{n_i^2 W_B q A}{N_A \tau_b} \exp\left(\frac{V_{BE}}{V_T}\right) = ③ \quad *$$

minority-carrier charge in base
minority carrier lifetime in base

Define Forward Current Gain = β_F :

$$\beta_F = \frac{I_C}{I_B} = \frac{①}{③ + ②} = \frac{\frac{qAD_{pE}n_i^2}{N_A W_B}}{\frac{1}{2} \frac{n_i^2 W_B q A}{N_A \tau_b} + \frac{qAD_{pE}n_i^2}{N_A W_E \tau_p}} = \left[\frac{W_B^2}{2 \tau_b D_{pE}} + \frac{D_{pE} W_B N_A}{D_{pB} W_E N_D} \right]^{-1}$$

- To maximize β_F , want:
- ① W_B = small
 - ② $N_{DE} \gg N_{AB}$ (this is why emitter is *mt*) \rightarrow also leads to $D_{pE} \ll D_{pB}$
 - ③ τ_b = large (base Si must be free of impurities/defects to prevent recombination)
- which we also want

More Complete Expression for β_F :

$$\beta_F = \underbrace{\frac{N_A W_B}{D_{pB}} \cdot \frac{D_{pE}}{N_A E L_{pE}}}_{\text{Injection Efficiency}} + \underbrace{\frac{1}{2} \left(\frac{W_B}{L_{pB}} \right)^2}_{\text{Volume Recombination}} + \underbrace{s \left(\frac{A_r}{A_E} \right) \left(\frac{W_B}{D_{pB}} \right)}_{\text{Surface Recombination}} + \underbrace{\frac{W_E N_A W_B}{2 D_{pB} \tau_i} e^{-\frac{V_{BE}}{2 V_T}}}_{\text{Recombination in the BE Depletion Region} \leftarrow \text{Significant @ low current levels}}$$

where: s = Surface recombination Velocity

D_i = Diffusion constant

N_i = Intrinsic carrier concentration

N_i = carrier concentration

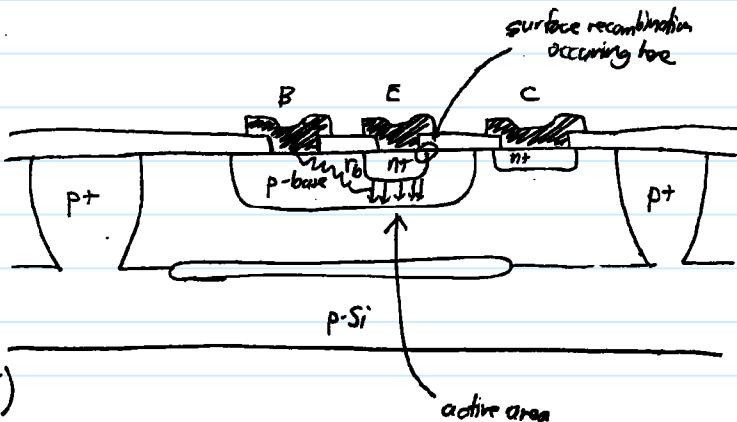
A_E = total emitter area

A_S = sidewall emitter area

τ = minority carrier lifetime

L_i = diffusion length ($L_i = \sqrt{D_i \tau}$)

W_B = active base width



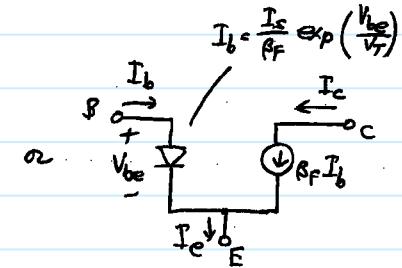
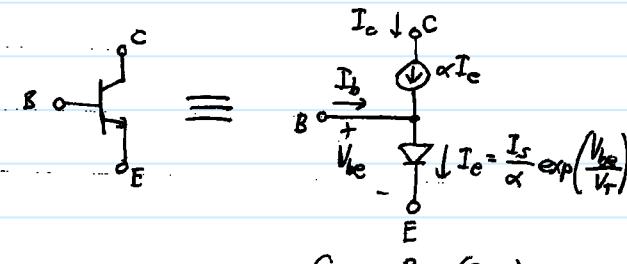
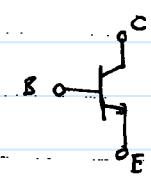
So β relates I_b & I_c . To relate I_c & I_e , use KCL:

$$\begin{array}{l} I_b \rightarrow \downarrow I_c \\ \downarrow I_e \end{array} \quad I_e = I_c + I_b = I_c + \frac{I_c}{\beta} = \left(1 + \frac{1}{\beta}\right) I_c$$

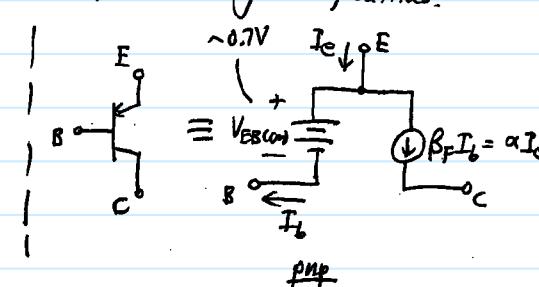
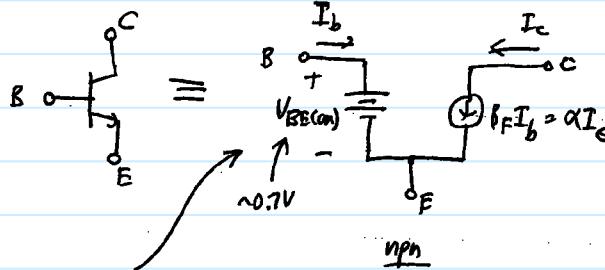
$$\Rightarrow I_c = \left(\frac{1}{1 + \frac{1}{\beta}}\right) I_e = \left(\frac{\beta}{\beta + 1}\right) I_e = \alpha I_e, \text{ where } \alpha = \frac{\beta}{\beta + 1} \Rightarrow \beta = \frac{\alpha}{1 - \alpha}$$

Equivalent Large Signal Ckt. Models for Forward-Active BJTs

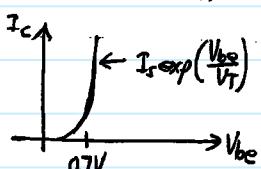
There are several of them. The most useful ones are:



But usually one doesn't have to use these complicated models. Rather, the following usually suffice:



Just as in a diode:



You should already be used to using approximate models like this
⇒ the more complicated models are a waste of time in comparison

③ Reverse-Active Region -

⇒ very similar to forward-active region except now: BEJ reverse-biased

BCJ forward-biased

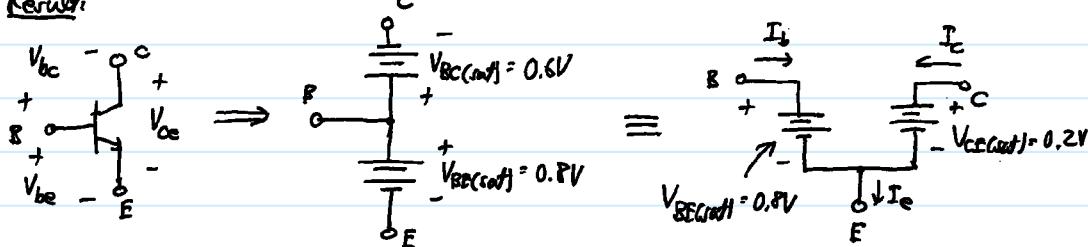
⇒ one important difference: $\beta_R \propto \frac{N_{DC} D_{PC}}{N_{AB} W_B D_{PB}}$ since collection is $n-$
 $\rightarrow N_{DC} \ll N_{AB} \rightarrow D_{PB} \ll D_{PC}$
 $\therefore \beta_R$ is much smaller than β_F
 \Rightarrow poor device performance

(4) Saturation Region -

BEJ forward-biased $\rightarrow V_{BE(\text{sat})} \sim 0.8V$ (higher than 0.7V in saturation)

BCJ forward-biased $\rightarrow V_{BC(\text{sat})} \sim 0.6V$

Result:



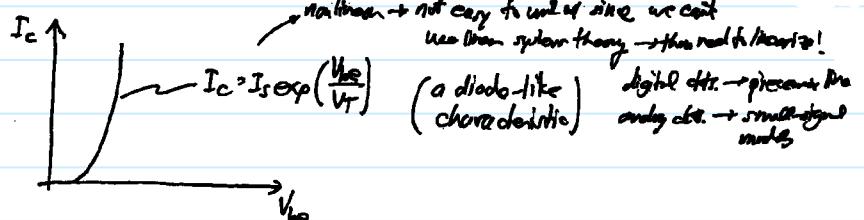
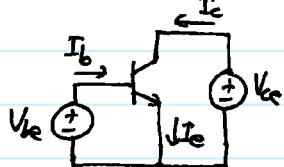
\Rightarrow Currents now determined by the attached elements & KCL:

$$I_c = I_b + I_e ; \text{ no longer true } I_b = \frac{I_c}{\beta} \text{ or } I_c = \alpha I_e$$

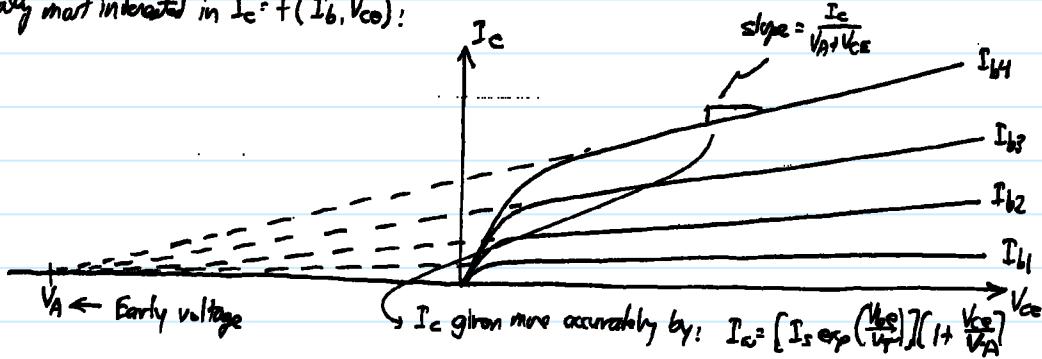
These no longer apply when BJT is in saturation.

When determining DC operating point:

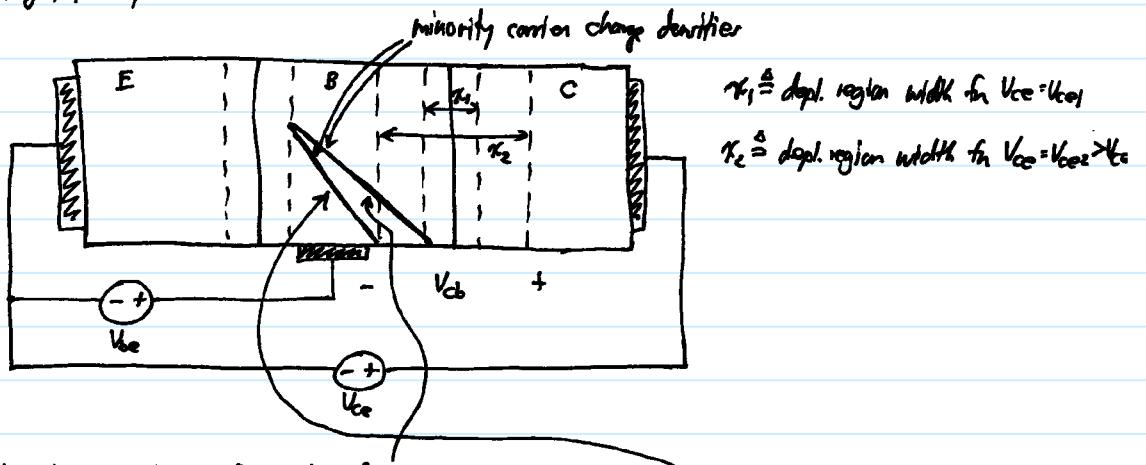
- Pass (
- ① Assume forward-active \rightarrow check for cut-off (enough V_{be} ?)
 - ② Determine V_{ce} .
 - ③ If $V_{ce} > V_{CE(\text{sat})} = 0.2V$, then ok (i.e., it's forward-active) ... otherwise, must do the analysis over assuming saturation.

IV Characteristics of Bipolar Junction Transistors

\Rightarrow really most interested in $I_c = f(I_b, V_{ce})$:



What is happening physically?



- ① Case: $V_{be} = V_{be1} \rightarrow x_1 \rightarrow I_{c1} \propto$ slope of this curve
- ② Now, increase $V_{ce1} \rightarrow V_{ce2} \rightarrow V_{cb} \uparrow \rightarrow x_2$ to $x_2 \rightarrow I_{c2} \propto$ slope of this line
 $\therefore I_{c2} > I_{c1}$

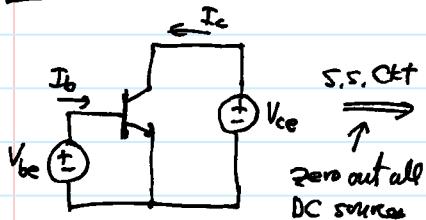
Thus, $V_{ce} \uparrow \rightarrow I_c \uparrow$ due to $x_{dep.} \uparrow$

Result: $I_c = f(I_b, V_{ce})$ in forward-active!

$$I_c = \left[I_s \exp\left(\frac{V_{be}}{V_T}\right) \right] \left[+ \frac{V_{ce}}{V_A} \right]$$

This, V_{ce} , is a more accurate I_c equation.

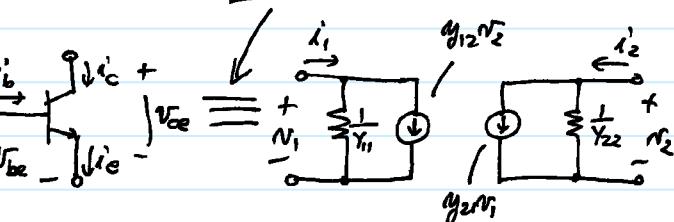
Small-Signal Model for Forward-Active Bipolar Transistor



S.S. Ckt

Zero out all DC sources

Y-Parameter Model

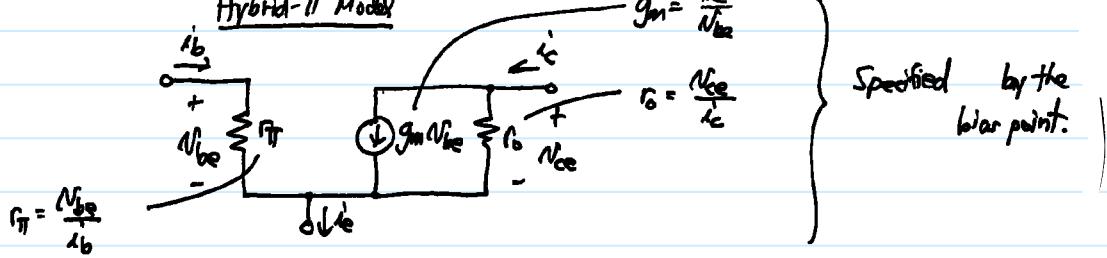


If only interested in the forward direction

$$y_{11} = \frac{i_1}{v_{be}} \Big|_{V_{ce}=0} \quad y_{21} = \frac{i_2}{v_{be}} \Big|_{V_{ce}=0}$$

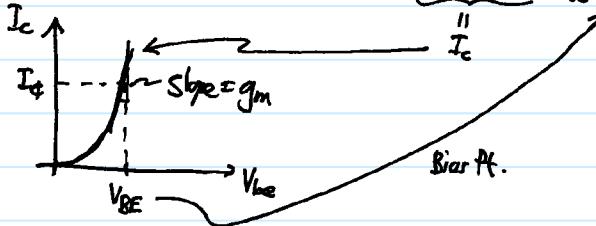
$$y_{12} = \frac{i_1}{v_{ce}} \Big|_{V_{be}=0} \quad y_{22} = \frac{i_2}{v_{ce}} \Big|_{V_{be}=0}$$

Hybrid- π Model



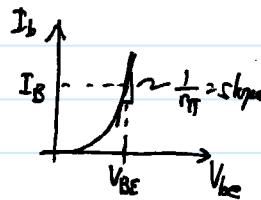
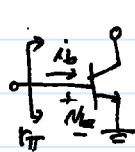
Determine the S.S. elements-

$$g_m = \frac{i_c}{N_{be}} = \left. \frac{\partial I_c}{\partial V_{be}} \right|_{Q\text{pt.}} = \left. \frac{\partial}{\partial V_{be}} \left[I_s \exp \left(\frac{V_{be}}{V_T} \right) \right] \right|_{V_{be}=V_{BE}} = \frac{I_c}{V_T} \exp \left(\frac{V_{BE}}{V_T} \right) \Rightarrow g_m = \frac{I_c}{V_T}$$



Note: function of the DC operating pt.

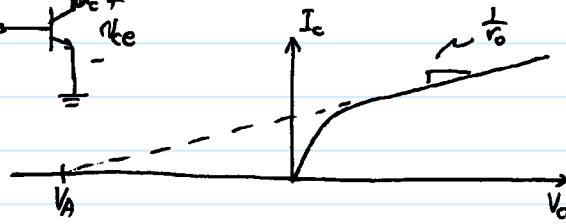
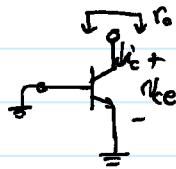
$$r_\pi = \frac{N_{be}}{i_b} :$$



$$r_\pi = \frac{N_{be}}{i_b} = \frac{N_{be}}{\frac{i_c}{\beta}} = \frac{\beta}{g_m} = \frac{\beta}{\frac{I_c}{V_T}} = \frac{V_T}{I_c}$$

$$\therefore r_\pi = \frac{\beta}{g_m} = \frac{V_T}{I_c} \quad \text{Again, function of the DC operating pt.}$$

$$r_o = \frac{N_{ce}}{i_c} :$$



$$r_o = \left. \frac{\partial V_{ce}}{\partial I_c} \right|_Q = \left[\left. \frac{\partial I_c}{\partial V_{ce}} \right|_{Q\text{pt.}} \right]^{-1}$$

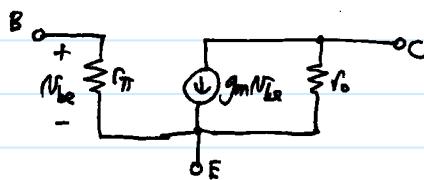
$$= \left[\left. \frac{\partial}{\partial V_{ce}} \left[I_s \exp \left(\frac{V_{be}}{V_T} \right) \right] \left[1 + \frac{V_{ce}}{V_A} \right] \right|_{V_{be}=V_{BE}} \right]^{-1}$$

$$= \frac{I_s \exp \left(\frac{V_{BE}}{V_T} \right)}{V_A} \left[\frac{I_c}{V_A + V_{CE}} \right]^{-1} = \frac{V_A + V_{CE}}{I_c}$$

$$\frac{I_c}{1 + \frac{V_{ce}}{V_A}}$$

$$\therefore r_o = \frac{V_A + V_{CE}}{I_c} \approx \frac{V_A}{I_c} \quad (V_A \gg V_{CE})$$

... and thus, we have the hybrid- π model:



$$\begin{aligned} \text{Slope: RF} & \quad r_\pi = \frac{\beta}{g_m} = \frac{V_T}{I_c} \\ g_m &= \frac{I_c}{V_T} \\ r_o &= \frac{V_A + V_{CE}}{I_c} \approx \frac{V_A}{I_c} \end{aligned}$$

Slope: VMF

Remarks:

i.e., β, I_c

quite different from MGF,
as we'll see

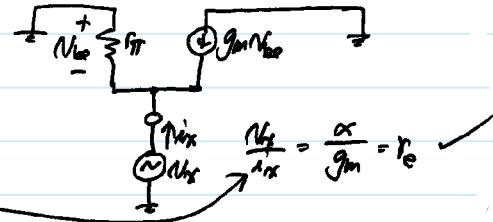
- ① g_m is independent of device specifics; depends only on temperature (thru V_T) and biasing I_c
- ② small-signal model valid for $N_{be} \ll V_T \ll 26\text{mV}$ @ 300K

What about emitter resistance?

$$\begin{aligned} r_e &= \frac{N_{be}}{I_e} = \frac{N_{be}}{\frac{i_e}{\alpha}} = \frac{N_{be}}{\frac{i_e}{\alpha}} = \frac{\alpha}{g_m} = \frac{\alpha V_T}{I_E} = \frac{V_T}{I_E} \\ &\Rightarrow r_e = \frac{\alpha}{g_m} \approx \frac{1}{g_m} \approx \frac{V_T}{I_E} \end{aligned}$$

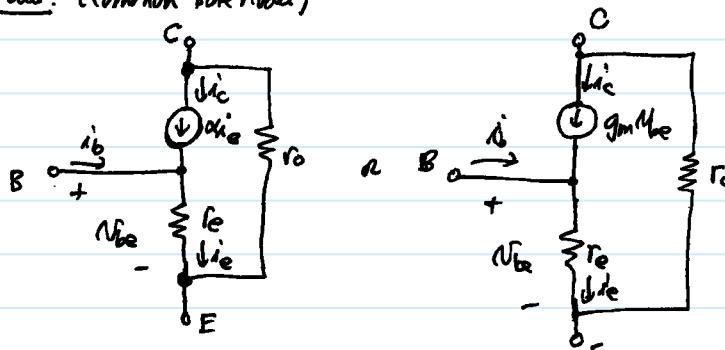
Note that although it's not explicitly shown in the hybrid-T model, r_e is present.

⇒ i.e., if you analyze this, you find that



To explicitly show emitter resistance, use the T-Model:

T-Model: (Common Base Model)



where as before:

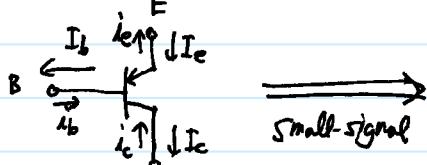
$$g_m = \frac{I_e}{V_T}$$

$$r_e = \frac{V_T}{I_E} = \frac{\alpha}{g_m} \approx \frac{1}{g_m}$$

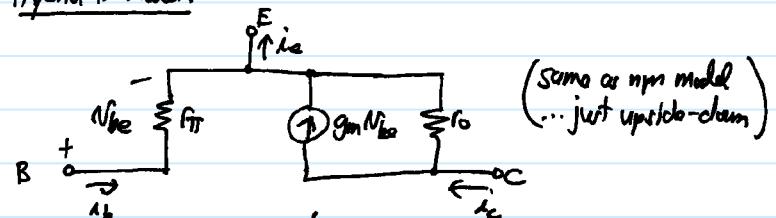
Small-Signal Models for pnp Transistors

relative

For pnp transistors, use the same small-signal models as npn with no change in polarities!



Hybrid-T Model:



Note that in these S.S. models,

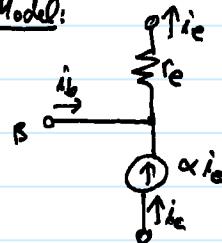
the same current directions as used for npn are used here

⇒ i.e., no change in S.S.

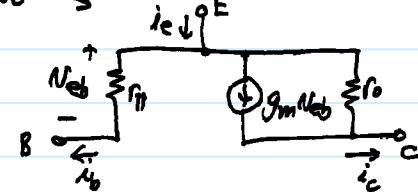
polarities

(large-signal directions, however, can be as before)

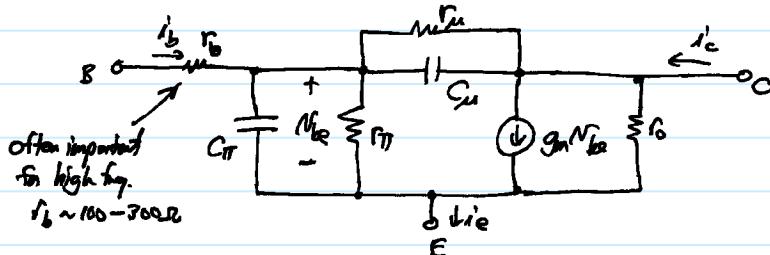
T-Model:



or

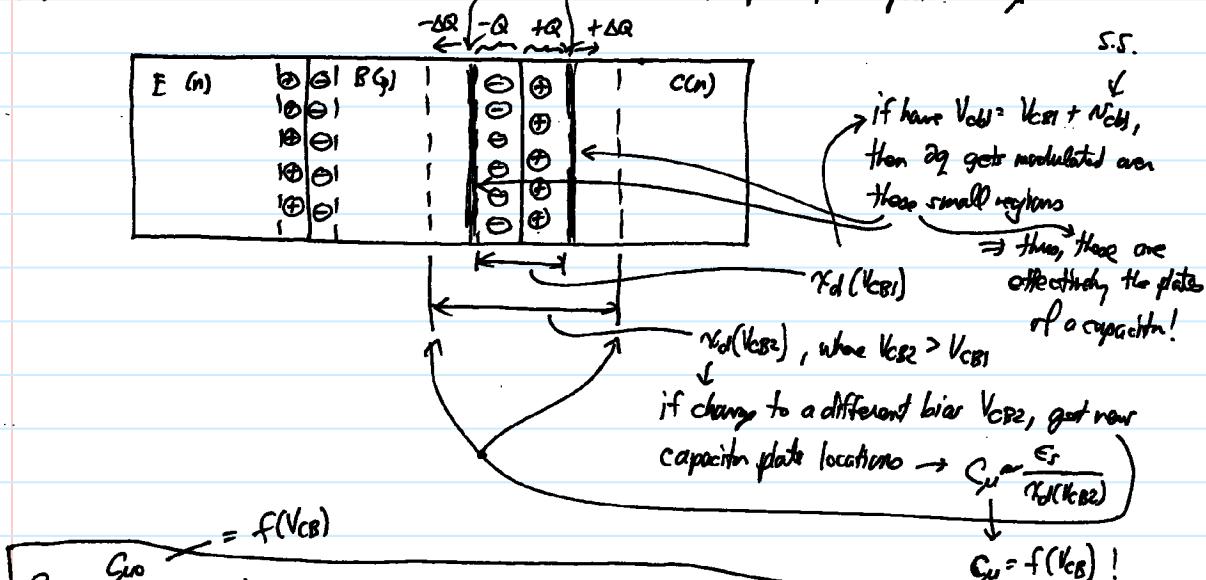


More Complete Hybrid-T Model (adding frequency effects & 2nd order effects)



C_μ - Base-to-Collector Capacitance

charge modulates here ∵ there are the plates of a capacitor $\rightarrow C_\mu$



$$C_\mu = \frac{C_{\mu 0}}{\sqrt{1 + \frac{V_{CB}}{V_{BE}}}} \quad \text{where } C_{\mu 0} = \text{capacitance for } V_{CB} = 0$$

$\phi_j = \text{function of the built-in potential between p and n-type semiconductors}$

$$\left. \phi_j = \frac{kT}{q} \ln \left(\frac{N_A N_D}{n_i^2} \right) \right|_{1.45 \times 10^{10} \text{ cm}^{-3}}$$

In general:

$$C_\mu = \frac{C_{\mu 0}}{\left(1 + \frac{V_{CB}}{V_{BE}} \right)^m}, \quad \text{where } m = \frac{1}{2} \text{ or } \frac{1}{3} \text{ depending upon how abrupt the junction is}$$

Detailed Derivation: (PTI)

$$x_d \approx x_0 = \left[\frac{2e(V_0 + V_{CB})}{qN_A(1 + \frac{N_A}{N_D})} \right]^{\frac{1}{2}} \rightarrow Q = qN_A A x_d = A \left[\frac{2e q N_A (V_0 + V_{CB})}{1 + \frac{N_A}{N_D}} \right]^{\frac{1}{2}}$$

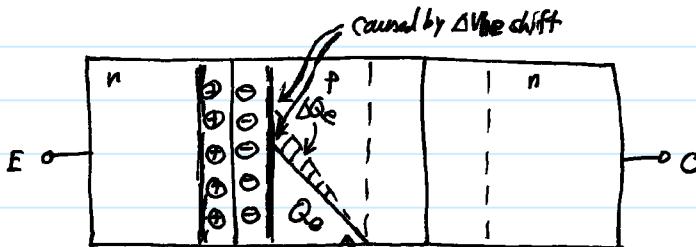
$[N_A \ll N_D]$

$$C_J = \frac{dQ}{dV_{CB}} \Big|_{V_{CB}} = \left[\frac{2e q N_A}{1 + \frac{N_A}{N_D}} \right]^{\frac{1}{2}} \frac{A}{2} (k + k_{BS})^{-\frac{1}{2}} = A \left[\frac{q e N_A N_D}{2(N_A + N_D)} \right]^{\frac{1}{2}} \frac{1}{\sqrt{k + k_{BS}}} = C_J |_{V_{CB}}$$

$$C_J = \frac{\epsilon_s A}{x_d (k_{BS})}$$

C_{π} - Base-to-Emitter Capacitance -

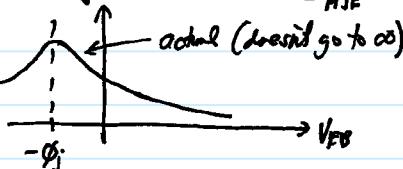
Two components comprise C_{π} : ① Junction capacitance, C_{je}
 ② Diffusion capacitance, C_b



Plates of a junction capacitor:

$$C_{je} = \frac{C_{je0}}{\left(1 + \frac{V_{FB}}{V_0}\right)^m}$$

bias level determines when the plates are in series:
 C_{je}
 V_{JE}
 H_{JE}



$$C_{\pi} = C_b + C_{je} \approx 2C_{je0}$$

$$C_{\pi} = C_{je0} \frac{1}{\left(1 + \frac{V_{FB}}{V_0}\right)^m}$$

Diffusion capacitance: (or Base Charging Capacitance)

⇒ Can define a base transit time:

$$\tau_F = \frac{Q_e}{I_c} = \frac{x_B^2}{2D_n} \quad \left. \begin{array}{l} \text{any time spent by} \\ \text{carrier in crossing base} \end{array} \right.$$

think of I_c as the rate of x_B of charge through the base

$$Q_e = \tau_F I_c$$

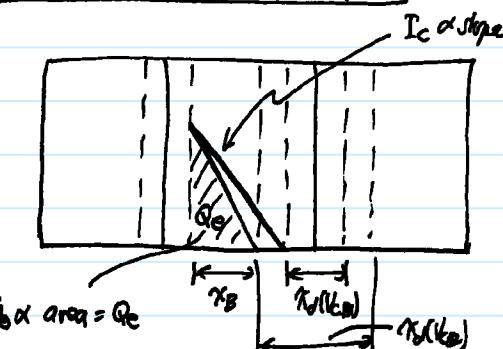
$$\Delta Q_e = \tau_F \Delta I_c$$

Switch to S.S. parameters (variables):

$$q_e = \tau_F i_c$$

$$q_e = C_b N_{be} \rightarrow C_b = \frac{q}{N_{be}} = \tau_F \frac{i_c}{N_{be}} = \boxed{\tau_F g_m = \tau_F \frac{I_c}{V_T} = C_b}$$

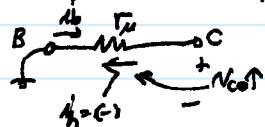
$$\therefore C_b \propto I_c$$

Collector-to-Base Feedback Resistor, r_{cb} 

Remember, recombination base current $I_{RB} > \frac{Q_e}{C_b}$!

∴ $N_{ce} \uparrow \rightarrow N_{B} \downarrow \rightarrow Q_e \downarrow \rightarrow i_b \downarrow$
 $\rightarrow i_c \uparrow$ (due to Early effect)

$N_{ce} \uparrow \rightarrow i_b \downarrow$ can be modeled by an r_{cb} connected G-to-B



$$\Rightarrow \text{here, } N_{be} = 0 \rightarrow N_{ce} = N_{cb}$$

$\therefore \frac{i_c}{N_{ce}} = \frac{1}{R_0} = \frac{i_c}{N_{cb}} = \frac{\beta i_b}{N_{cb}} \rightarrow \frac{N_{cb}}{i_b} = \beta R_0 = r_o$

$r_o = r_o$
 assuming all of i_b is
 recombination current

In general, base recombination current is only part of the total base current and is the only component dependent on V_{bc} \Rightarrow thus, $I_b > I_{br} \rightarrow I_b = I_{br} + I_{bc}$

$$T_M > \beta_0 r_0 \rightarrow T_M = 2 - 10 \beta_0 r_0$$

\uparrow \uparrow
lateral pump pump $\rightarrow I_b$ is 10% recumb.

where base occurs more significant

Complete Forward Active BJT S.S. Model (including parasitics)

\Rightarrow Actual integrated BJT:

should draw this on the board

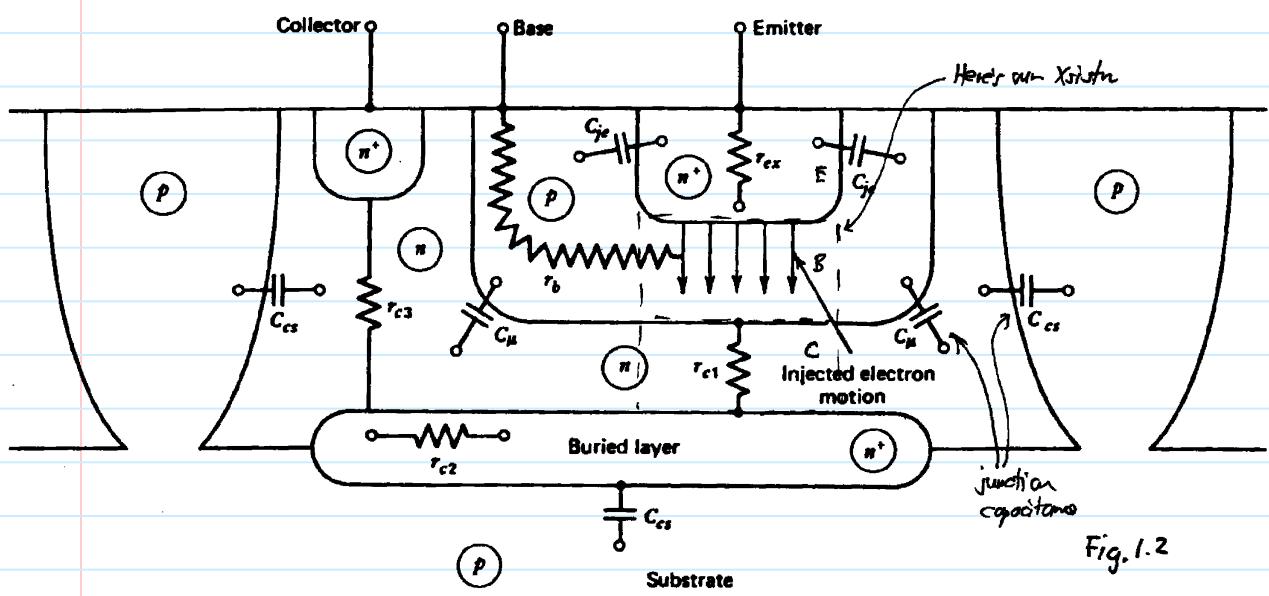
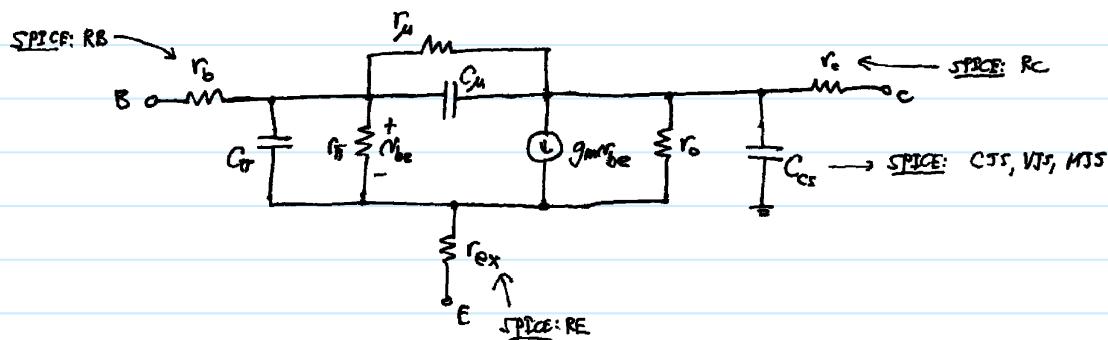


Fig. 1.2



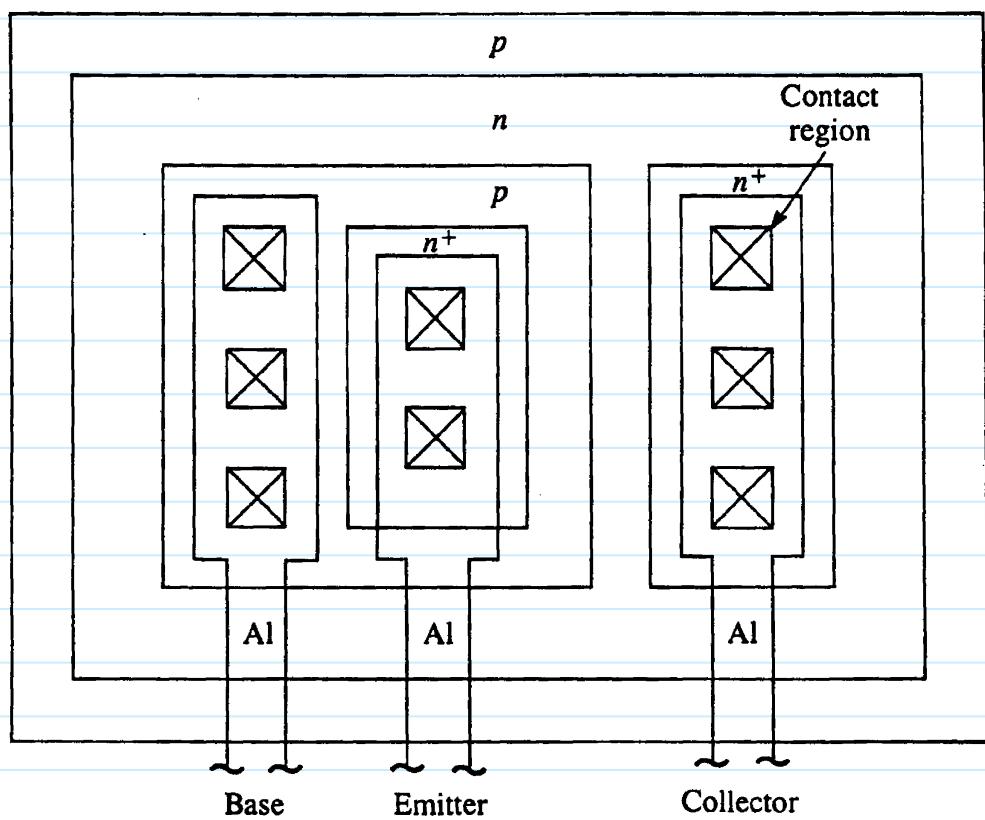
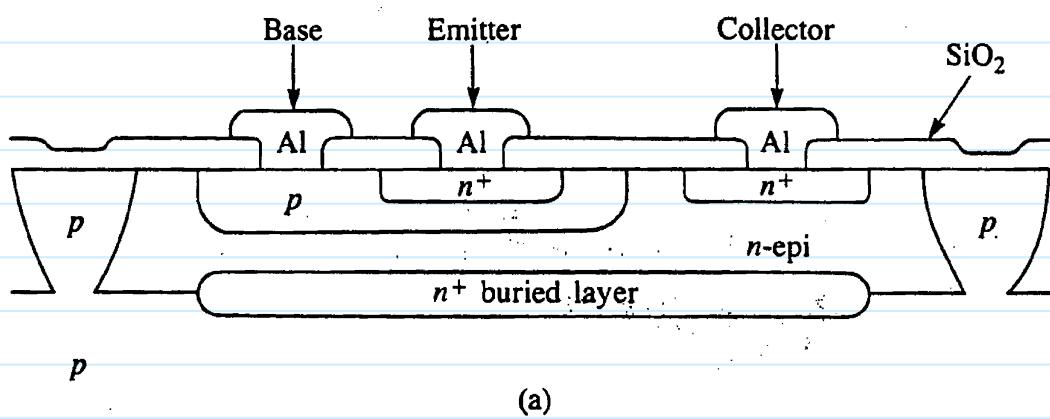
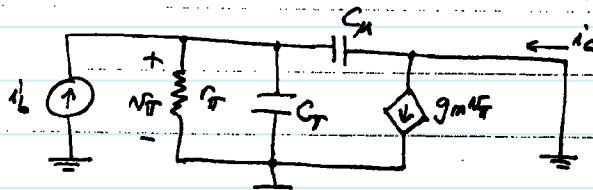


Fig. 1.1

f_T (unity gain freq. $\text{fm } \beta$)

Find $\beta(j\omega)$: (β as a function of freq.)



Find $\frac{i_c}{v_b}|_{\omega \rightarrow 0}$:

$$N_{fb} = v_b \left(r_o \parallel \frac{1}{sC_T} \parallel \frac{1}{sC_L} \right) \quad [g_m \gg sC_T]$$

$$i_c = g_m N_{fb} - sC_L N_{fb} \cdot (g_m - sC_L) N_{fb} \approx g_m N_{fb}$$

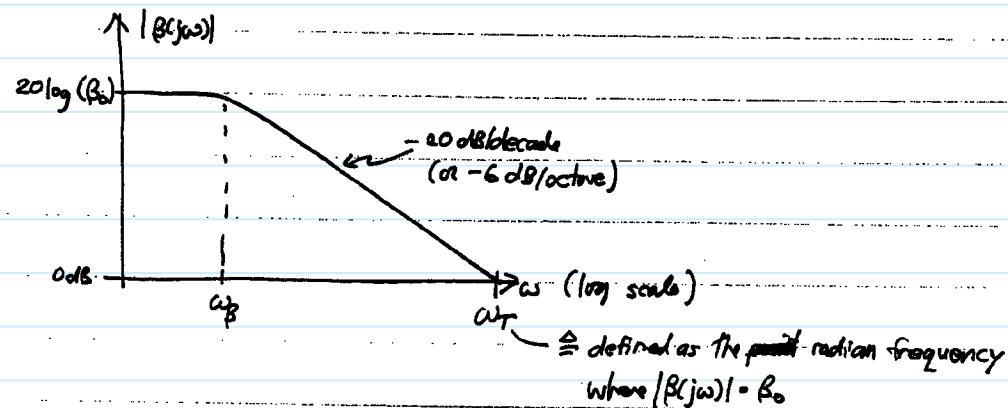
$$i_c = g_m (r_o \parallel \frac{1}{sC_T} \parallel \frac{1}{sC_L}) v_b$$

$$\frac{i_c}{v_b} = \frac{g_m}{\frac{1}{r_o} + s(C_T + C_L)} = \frac{g_m r_o}{(1 + s r_o (C_T + C_L))} = \frac{\beta_0}{1 + s r_o (C_T + C_L)} \quad [\beta_0 = g_m r_o] \quad (\text{low freq. } \beta)$$

Plot $|\beta(j\omega)|$: (Bode plot)

$$\beta(j\omega) = \frac{\beta_0}{1 + \frac{j\omega}{\omega_B}}$$

$$\omega_B = \frac{1}{r_o (C_T + C_L)}$$



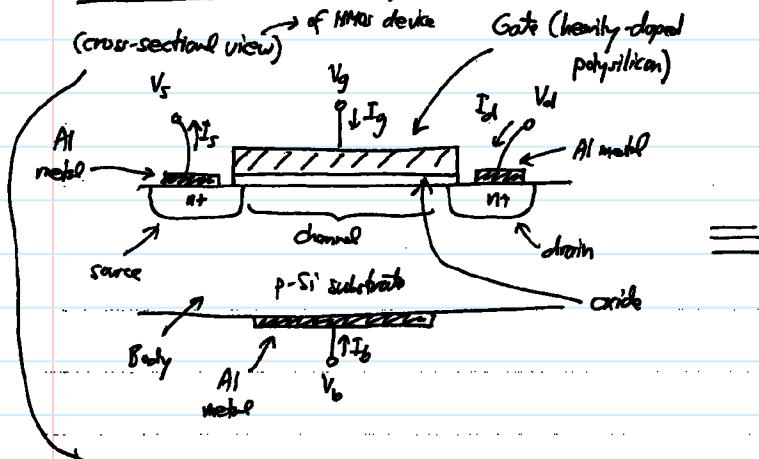
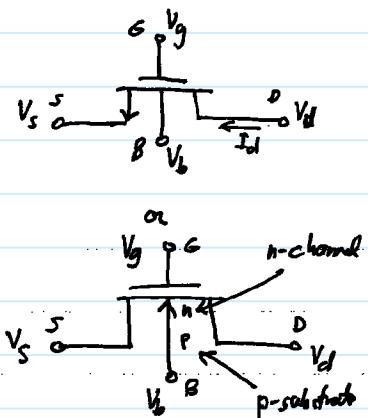
For ω large: (e.g. ω close to ω_T)

$$|\beta(j\omega)| \approx \frac{\beta_0}{\omega_T r_o (C_T + C_L)} = 1 \rightarrow \omega_T = \frac{g_m}{C_T + C_L} \Rightarrow f_T = \frac{\omega_T}{2\pi} \quad \text{is a figure of merit for the frequency performance of a transistor.}$$

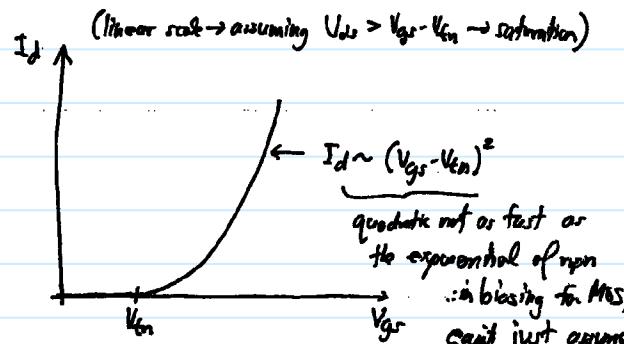
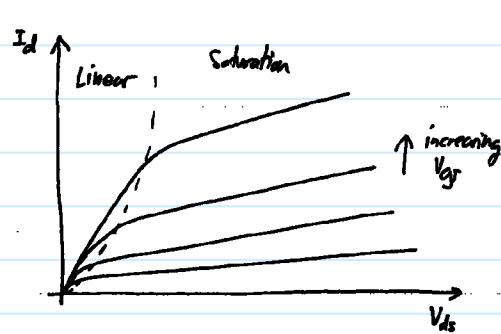
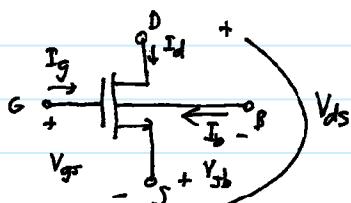
Also, note that $\omega_T = \beta_0 \omega_B$

$$C_T = \frac{g_m}{\omega_T} - C_L$$

$f_T = 100 \text{ MHz} \rightarrow 15 \text{ GHz}$ for bipolar X-tal.

MOS TransistorPhysical Structure & Device Symbols -NMOS Transistor Device Symbol

But first start w/ a perspective-view: (This also defines dimensions)
use the photograph on next page → pg. 14a

IV Characteristics (NMOS)NMOS Transistor Mathematical Model① Cut-Off Region: ($V_{gs} \leq V_t$)

$$I_g = I_b = 0; I_d = 0$$

② Linear (or Triode) Region: ($V_{gs} - V_{th} \geq V_{dr} \geq 0$)

$$I_g = I_b = 0; I_d = \mu_n C_{ox} \frac{W}{L} \left(V_{gs} - V_{th} - \frac{V_{dr}}{2} \right) V_{dr}$$

$$\text{Body Factor} \rightarrow \gamma = \frac{1}{C_{ox}} \sqrt{2q\epsilon_s N_{sub}} \leftarrow \text{substrate doping conc.}$$

$$= k_n \left(V_{gs} - V_{th} - \frac{V_{dr}}{2} \right) V_{dr}$$

General:

$$k_n = k'_n \frac{W}{L} = \mu_n C_{ox} \frac{W}{L}$$

$I_g, I_b = 0$ for all regions (at least for dc)

$$V_{th} = f(V_{sb}) = V_{th0} + \gamma (\sqrt{V_{sb} + 2V_{th0}} - \sqrt{2V_{th0}})$$

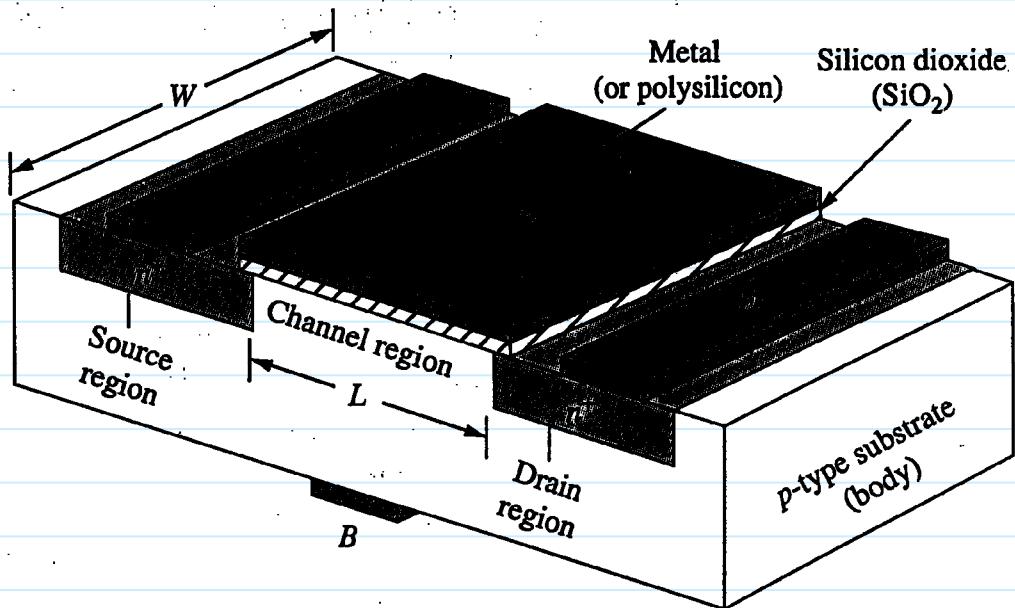
③ Saturation Region: ($V_{dr} \geq V_{gs} - V_{th} \geq 0$)

$$I_g = I_b = 0; I_d = \frac{1}{2} \mu_n C_{ox} \frac{W}{L} (V_{gs} - V_{th})^2 (1 + \gamma V_{ds})$$

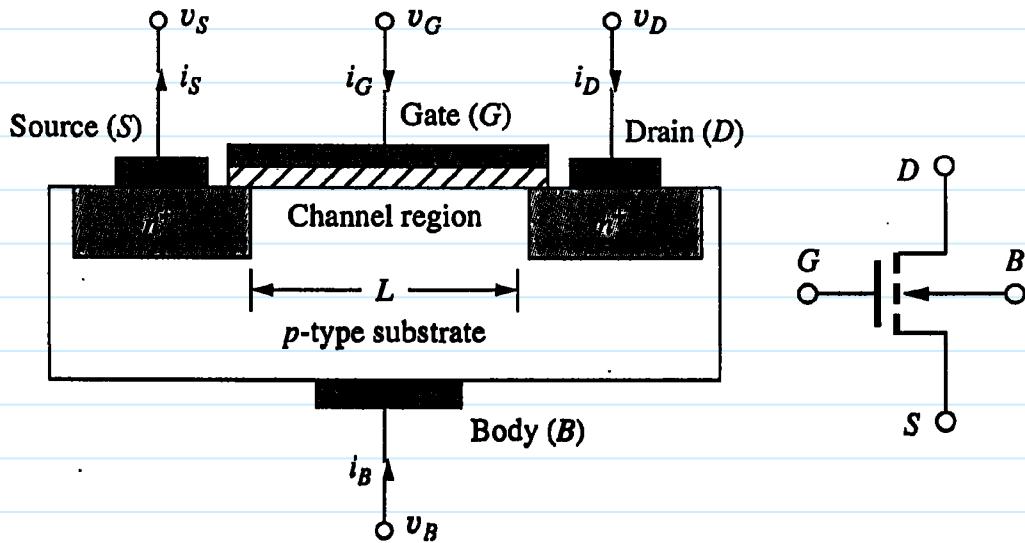
$$= \frac{1}{2} k_n (V_{gs} - V_{th})^2 (1 + \gamma V_{ds})$$

$\mu_n \triangleq$ mobility in the channel

$C_{ox} \triangleq$ gate oxide capacitance per unit area



(a)

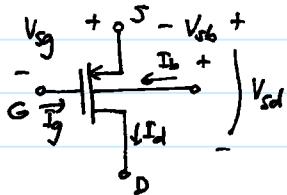


(b)

(c)

Fig. 2.1

PMOS Xitan Mathematical Model



① Cut-off Region: $(V_{SG} \leq -V_{tp}) \text{ or } (|V_{SG}| \geq |V_{tp}|)$
 $I_{SD} = 0$

② Linear (or Triode) Region: $(V_{SG} + V_t \geq V_{SD} \geq 0; \text{ or } (|V_{SG}| - |V_{tp}| \geq |V_{SD}| \geq 0))$

$$I_{SD} = k_p (V_{SG} + V_t - \frac{V_{SD}}{2}) V_{SD} = \mu_p C_{ox} \frac{W}{L} (V_{SG} + V_t - \frac{V_{SD}}{2}) V_{SD}$$

$$= \mu_p C_{ox} \frac{W}{L} (|V_{SG}| - |V_{tp}| - \frac{|V_{SD}|}{2}) |V_{SD}|$$

For all regions:

$$k_p = k'_p \frac{W}{L} = \mu_p C_{ox} \frac{W}{L}$$

$I_g = 0$ and $I_b = 0$ (at dc)

$$V_{tp} = V_{to} - \sqrt{(V_{BS} + |V_{tp}| - \sqrt{2k'_p|V_{sd}|})}$$

③ Saturation Region: $(V_{SD} \geq V_{SG} + V_t \geq 0; |V_{DS}| \geq |V_{SG}| - |V_{tp}| \geq 0)$

$$I_{SD} = \frac{1}{2} \mu_p C_{ox} \frac{W}{L} (V_{SG} + V_t)^2 (1 + \lambda V_{SD}) = \frac{1}{2} k_p (V_{SG} + V_t)^2 (1 + \lambda V_{SD})$$

$$= \frac{1}{2} \mu_p C_{ox} \frac{W}{L} (|V_{SG}| - |V_{tp}|)^2 (1 + \lambda |V_{SD}|)$$

$\mu_p \triangleq h^+$ mobility in the channel

$C_{ox} \triangleq$ gate oxide capacitance per unit area

Threshold Voltage

$$V_t = \phi_{ms} - \psi_s - \frac{Q_B}{C_{ox}} - \frac{Q_{ss}}{C_{ox}}$$

, where ϕ_{ms} = work function difference [in V] between gate material and bulk Si

ψ_s = surface potential in Si at onset of strong inversion

= $2\phi_f$ for uniformly doped substrate ($\phi_f \sim 0.3$ V)

Q_{ss} = oxide charge per unit area at the oxide-Si interface [C/cm^2]

Q_B = charge stored per unit area in the depletion region (at onset of inversion)

$$\Rightarrow |Q_B| = \sqrt{2q\epsilon_s N_B (2|\phi_f| + |V_{SB}|)} \quad [C/cm^2]$$

\uparrow conc. in bulk \nwarrow reverse bias

C_{ox} = gate oxide capacitance per unit area [F/cm^2]

Case: $V_{SB} = 0 \Rightarrow V_t (V_{SB} = 0) = V_{t0} = \phi_{ms} - 2\phi_f - \frac{Q_{ss}}{C_{ox}} - \frac{Q_{B0}}{C_{ox}}$, where

Then:

$$V_t = \phi_{ms} - 2\phi_f - \frac{Q_{ss}}{C_{ox}} - \frac{Q_{B0}}{C_{ox}}$$

$$= \phi_{ms} - 2\phi_f - \frac{Q_{ss}}{C_{ox}} - \frac{Q_{B0}}{C_{ox}} - \frac{Q_B - Q_{B0}}{C_{ox}}$$

$$\underbrace{V_{t0}}$$

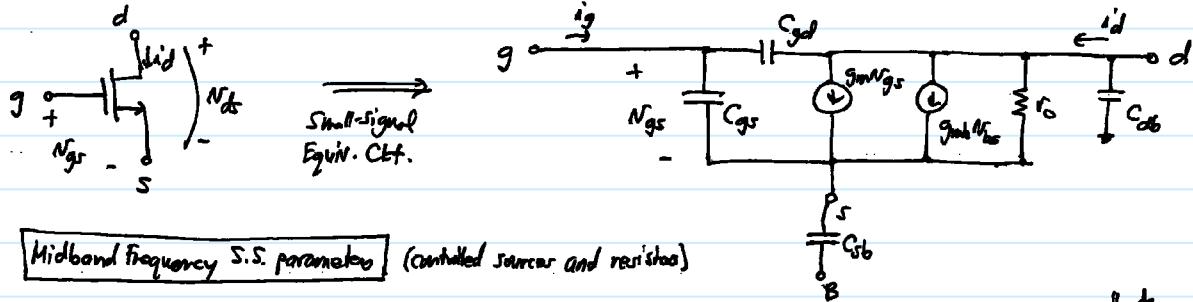
$$Q_{B0} = \sqrt{2q\epsilon_{Si}N_B(2|\phi_f| + |V_{SB}|)}$$

$$V_t = V_{t0} - \gamma \left(\sqrt{2|\phi_f| + |V_{SB}|} - \sqrt{2\phi_f} \right), \quad \gamma = \frac{1}{C_{ox}} \sqrt{2q\epsilon_{Si}N_B}$$

Signs in the V_t Equation:

<u>Parameter</u>	<u>NMOS</u>	<u>PMOS</u>
Substrate	p-type	n-type
ϕ_{ms} : metal gate	-	-
n+ Si gate	-	-
p+ Si gate	+	+
ϕ_f	-	+
Q_{B0} (or Q_B)	-	+
Q_{ss}	+	+
γ	-	+
C_{ox}	+	+

Mos Small-Signal Model (for NMOS) ^{in saturation}



Midband frequency S.S. parameters (controlled source and resistance)

Transconductance, g_m :

$$g_m = \frac{i_d}{N_{ds}} = \left. \frac{\partial i_d}{\partial V_{gs}} \right|_{Q_{opt}} = \left. \frac{2}{\partial V_{gs}} \left(\frac{1}{2} \mu_n C_{ox} \frac{W}{L} (V_{gs} - V_{tn})^2 \right) \right|_{Q_{opt}} = \mu_n C_{ox} \frac{W}{L} (V_{gs} - V_{tn}) \Big|_{V_{gs}=V_{DS}}$$

$$g_m = \mu_n C_{ox} \frac{W}{L} (V_{gs} - V_{tn}) = \sqrt{2 \mu_n C_{ox} \frac{W}{L} I_0}$$

$$\left[I_0 = \frac{1}{2} \mu_n C_{ox} \frac{W}{L} (V_{gs} - V_{tn})^2 \rightarrow (V_{gs} - V_{tn}) = \sqrt{\frac{2 I_0}{\mu_n C_{ox} \frac{W}{L}}} \right]$$

$$g_{mb} = \frac{i_d}{N_{sb}} = \left. \frac{\partial i_d}{\partial V_{ds}} \right|_{Q_{opt}} = \left. \left(\frac{\partial i_d}{\partial V_{gs}} \cdot \frac{\partial V_{gs}}{\partial V_{ds}} \right) \right|_{Q_{opt}}$$

$$\left. \frac{\partial i_d}{\partial V_{ds}} \right|_{Q_{opt}} = - \left. \frac{\partial i_d}{\partial V_{gs}} \right|_{Q_{opt}} = -g_m ; \left. \frac{\partial V_{ds}}{\partial V_{gs}} \right|_{Q_{opt}} = \frac{2}{\partial V_{gs}} \left[V_{ds} + 2 \left(\sqrt{V_{ds} + 2V_{fb}} - \sqrt{2V_{fb}} \right) \right] \Big|_{Q_{opt}} = \frac{2}{2\sqrt{V_{ds} + 2V_{fb}}} = \eta$$

$$g_{mb} = \eta g_m \quad \text{Note: } V_{SB} \uparrow \rightarrow V_t \uparrow \rightarrow \eta \downarrow \rightarrow I_d \downarrow$$

often neglected!

\hookrightarrow g_{mb} is minimized by maximizing V_{SB} !

Output Resistance, r_o : ($= \frac{1}{g_{ds}}$)

$$\Rightarrow \text{output conductance } g_{ds} = \frac{i_d}{N_{ds}} = \left. \frac{\partial i_d}{\partial V_{ds}} \right|_{Q_{opt}} = \frac{2}{\partial V_{ds}} \left(\frac{1}{2} \mu_n C_{ox} \frac{W}{L} (V_{gs} - V_{tn})^2 (1 + \lambda V_{ds}) \right) \Big|_{Q_{opt}}$$

$$= \lambda I_{dsat} = \frac{\lambda I_0}{1 + \lambda V_{ds}} \approx \lambda I_0 = g_{ds}$$

$(1 \gg \lambda V_{ds})$

$$\therefore r_o = g_{ds}^{-1} = \frac{1}{\lambda I_0} = \frac{1}{\lambda + V_{ds}} \quad \text{if } V_{ds} \text{ is very large}$$

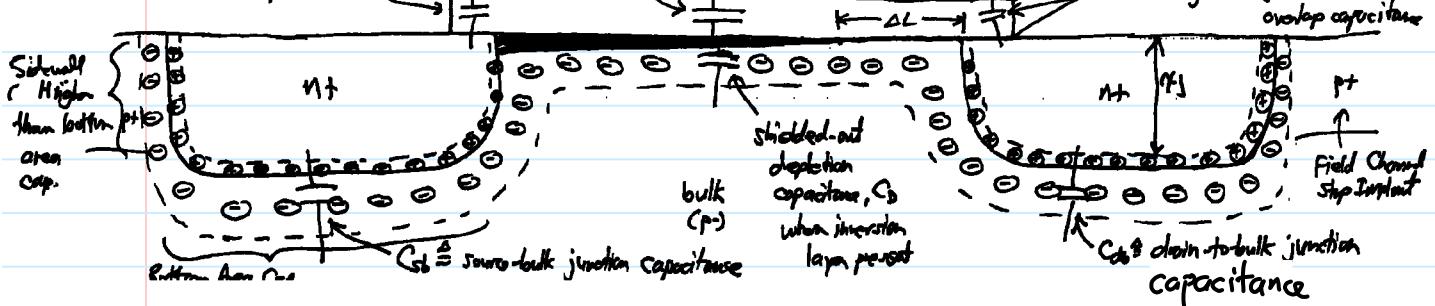
High Frequency S.S. Parameters (capacitors)

(cross-sectional view)

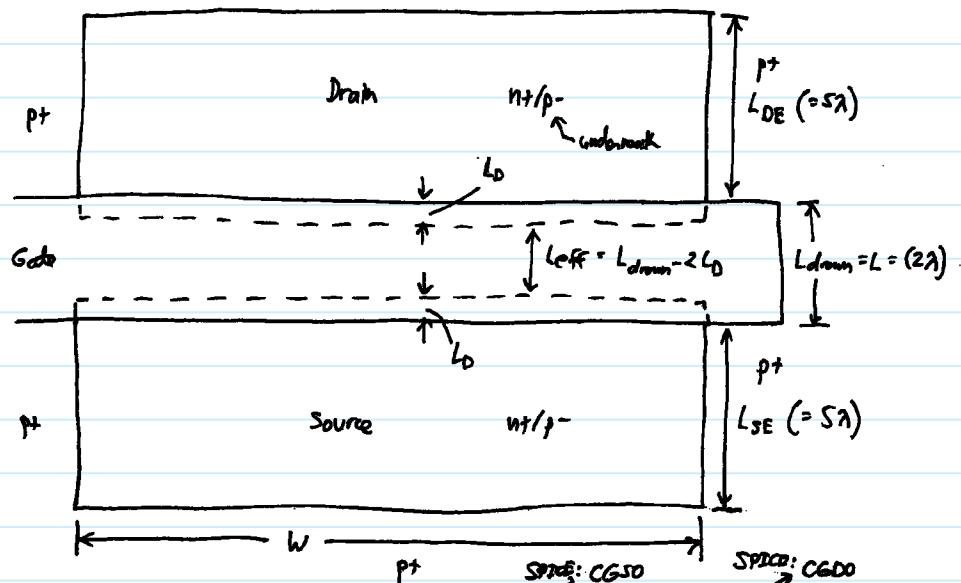
C_{gd} = gate-to-source overlap capacitance

C_g = gate capacitance
 $= W L_{eff} C_{ox}$

C_{gds} = gate-to-drain overlap capacitance

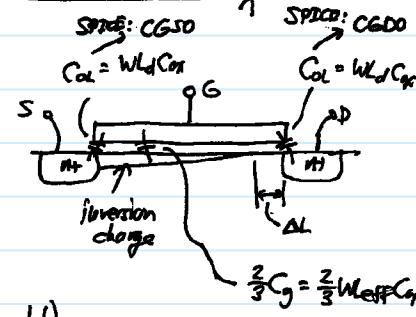


(layout view)



(still considering saturation region)

In saturation, the inversion charge is not present near the drain:

Gate-to-Source Capacitor, C_{gs} :

$$C_{gs} = C_{OL} + \frac{2}{3} W_{eff} C_{ox} \quad (\text{inversion charge integrated})$$

$$\frac{2}{3} C_g = \frac{2}{3} W_{eff} C_{ox}$$

obtained by integrating the charge over the gate length

Gate-to-Drain Capacitor, C_{gd} :

$$C_{gd} = C_{OL} \quad (\text{no inversion charge near the drain in saturation})$$

Source/Drain Junction Capacitance, $C_{sb} + C_{db}$: (must include this in SPICE simulations!)

⇒ there are depletion capacitors associated with drain-to-bulk and source-to-bulk pn junctions

⇒ bottom-side capacitance per unit area is different from that at sidewalls due to higher doping at the sidewalls
(there is higher doping in the field areas to prevent channels from forming
bulk
under interconnect wires)

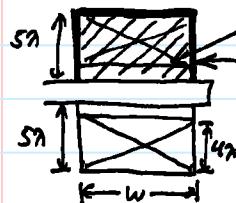
⇒ take drain capacitance as an example:

$$C_{db} = \frac{C_{db0}}{\sqrt{1 + \frac{V_{DB}}{V_0}}} , \quad C_{db0} \triangleq \text{depletion capacitance with } V_{DB} = 0V$$

$$\text{SPICE: } C_J \quad \text{bulk doping level}$$

$$C_{J0} = \frac{q \epsilon_s N_B}{2(V_0)^{1/2}} \rightarrow \left(\frac{q \epsilon_s N_B}{2(V_0)^{1/2}} \right)^M$$

depl. cap. per unit area @ bottom-side w/ $V_{DB} = 0V$



$$= (\text{junction bottom-side area}) C_{J0} + (\text{junction outside perimeter}) C_{JSW}$$

$$= W (5\lambda) C_{J0} + (W + 2(5\lambda)) C_{JSW}$$

depletion cap. along sidewall's per unit length for $V_{DB} = 0V$

$$C_{JSW} = \frac{q \epsilon_s N_C}{2(V_0)^{1/2}} \times \pi \lambda$$

SPICE: $C_{JSW} S / \lambda$ junction depth